

## 1.5SMB Series



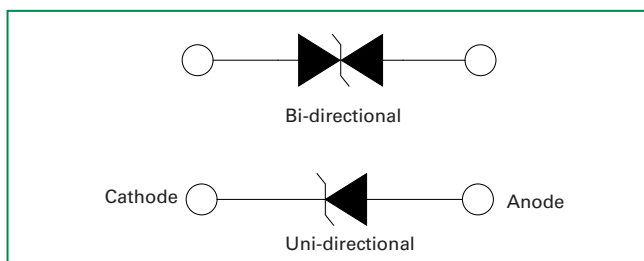
### Maximum Ratings and Thermal Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10/1000 $\mu\text{s}$ Waveform (Fig.2) (Note 1), (Note 2)	$P_{PPM}$	1500	W
Power Dissipation on Infinite Heat Sink at $T_A=50^\circ\text{C}$	$P_D$	5.0	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	$I_{FSM}$	120	A
Maximum Instantaneous Forward Voltage at 50A for Unidirectional Only	$V_F$	5.0	V
Operating Temperature Range	$T_J$	-65 to 150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to 175	$^\circ\text{C}$
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	20	$^\circ\text{C/W}$
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	100	$^\circ\text{C/W}$

**Notes:**

1. Non-repetitive current pulse, per Fig. 4 and derated above  $T_J$  (initial) =  $25^\circ\text{C}$  per Fig. 3.
2. Mounted on copper pad area of 0.2x0.2" (5.0 x 5.0mm) to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only, duty cycle=4 per minute maximum.

### Functional Diagram



### Description

The 1.5SMB Series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

### Features

- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2, 30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- Glass passivated chip junction
- 1500W peak pulse power capability at 10/1000 $\mu\text{s}$  waveform, repetition rate (duty cycles):0.01%
- $V_{BR} @ T_J = V_{BR} @ 25^\circ\text{C} \times (1 + \alpha T \times (T_J - 25))$   
( $\alpha$ : Temperature Coefficient, typical value is 0.1%)
- Excellent clamping capability
- Low incremental surge resistance
- Meet MSL level 1 per J-STD-020, and high temperature soldering guaranteed: 260C/10sec
- Matte tin lead-free Plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2<sup>nd</sup> level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

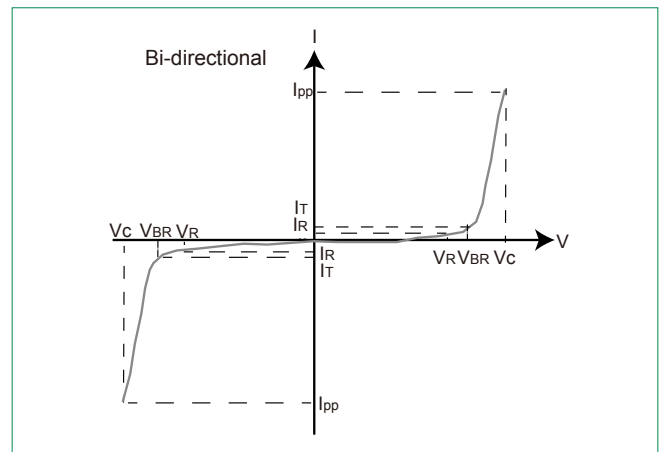
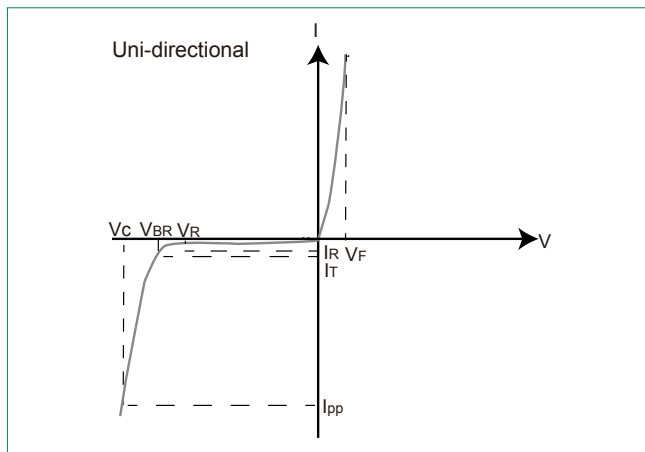
### Applications

TVS components are ideal for the protection of I/O Interfaces,  $V_{CC}$  bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Part Number (Uni)	Part Number (Bi)	Marking		Reverse Stand off Voltage V <sub>R</sub> (Volts)	Breakdown Voltage V <sub>BR</sub> (Volts) @ I <sub>T</sub>		Test Current I <sub>T</sub> (mA)	Maximum Clamping Voltage V <sub>C</sub> @ I <sub>pp</sub> (10/1000μs) (V)	Maximum Peak Pulse Current I <sub>pp</sub> (10/1000μs) (A)	Maximum Clamping Voltage V <sub>C</sub> @ I <sub>pp</sub> (8/20μs) (V)	Maximum Peak Pulse Current I <sub>pp</sub> (8/20μs) (A)	Maximum Reverse Leakage I <sub>R</sub> @ V <sub>R</sub> (μA)	Maximum Temperature coefficient of V <sub>BR</sub> (%/C)
		UNI	BI		MIN	MAX							
1.5SMB20A	1.5SMB20CA	H15I	B15I	17.1	19.0	21.0	1	27.7	54.9	34.8	302.0	20	0.085
1.5SMB22A	1.5SMB22CA	H15K	B15K	18.8	20.9	23.1	1	30.6	49.7	35.0	273.4	10	0.088
1.5SMB23A	1.5SMB23CA	H10L	B10L	20.0	22.0	24.2	1	33.2	45.0	35.0	250.0	1	0.088
1.5SMB24A	1.5SMB24CA	H15N	B15N	20.5	22.8	25.2	1	33.2	45.0	42.9	249.0	1	0.091
1.5SMB27A	1.5SMB27CA	H15P	B15P	23.1	25.7	28.4	1	37.5	40.5	48.4	222.8	1	0.092
1.5SMB30A	1.5SMB30CA	H15S	B15S	25.6	28.5	31.5	1	41.4	36.7	53.5	201.9	1	0.093
1.5SMB33A	1.5SMB33CA	H15V	B15V	28.2	31.4	34.7	1	45.7	33.3	59.0	183.2	1	0.094
1.5SMB36A	1.5SMB36CA	H15Z	B15Z	30.8	34.2	37.8	1	49.9	30.5	64.5	167.8	1	0.096
1.5SMB39A	1.5SMB39CA	N15B	C15B	33.3	37.1	41.0	1	53.9	28.2	69.6	155.1	1	0.097
1.5SMB43A	1.5SMB43CA	N15D	C15D	36.8	40.9	45.2	1	59.3	25.6	76.6	140.8	1	0.098
1.5SMB47A	1.5SMB47CA	N15F	C15F	40.2	44.7	49.4	1	64.8	23.5	83.7	129.3	1	0.099
1.5SMB51A	1.5SMB51CA	N15G	C15G	43.6	48.5	53.6	1	70.1	21.7	90.6	119.4	1	0.100
1.5SMB56A	1.5SMB56CA	N15I	C15I	47.8	53.2	58.8	1	77.0	19.7	99.5	108.4	1	0.101
1.5SMB62A	1.5SMB62CA	N15K	C15K	53.0	58.9	65.1	1	85.0	17.9	109.8	98.5	1	0.102
1.5SMB68A	1.5SMB68CA	N15L	C15L	58.1	64.6	71.4	1	92.0	16.5	118.9	90.8	1	0.103
1.5SMB75A	1.5SMB75CA	N15N	C15N	64.1	71.3	78.8	1	103.0	14.8	133.1	81.4	1	0.104
1.5SMB82A	1.5SMB82CA	N15P	C15P	70.1	77.9	86.1	1	113.0	13.5	146.0	74.3	1	0.105
1.5SMB91A	1.5SMB91CA	N15S	C15S	77.8	86.5	95.5	1	125.0	12.2	161.5	67.1	1	0.106
1.5SMB100A	1.5SMB100CA	N15V	C15V	85.5	95.0	105.0	1	137.0	11.1	177.0	61.1	1	0.106

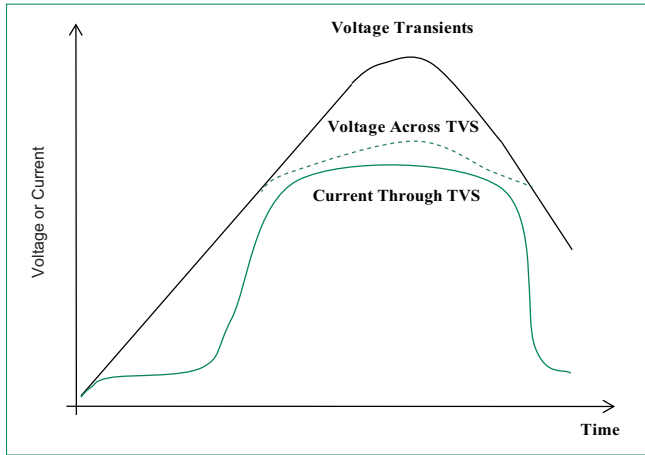
### I-V Curve Characteristics



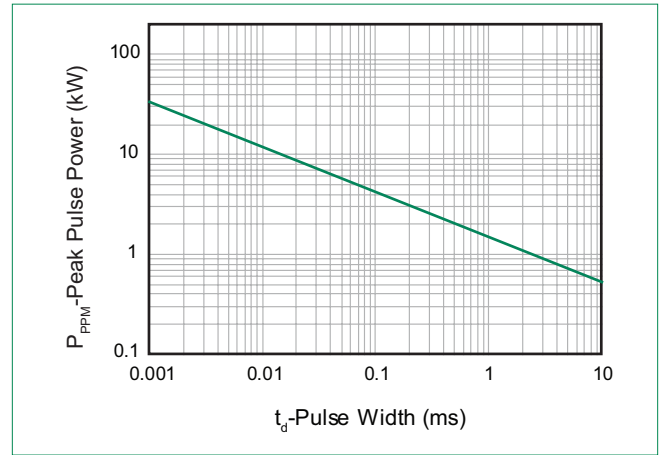
- P<sub>ppm</sub> Peak Pulse Power Dissipation** – Max power dissipation
- V<sub>R</sub> Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage** – Maximum voltage that flows though the TVS at a specified test current (I<sub>T</sub>)
- V<sub>C</sub> Clamping Voltage** – Peak voltage measured across the TVS at a specified I<sub>ppm</sub> (peak impulse current)
- I<sub>R</sub> Reverse Leakage Current** – Current measured at V<sub>R</sub>
- V<sub>F</sub> Forward Voltage Drop for Uni-directional**

**Ratings and Characteristic Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

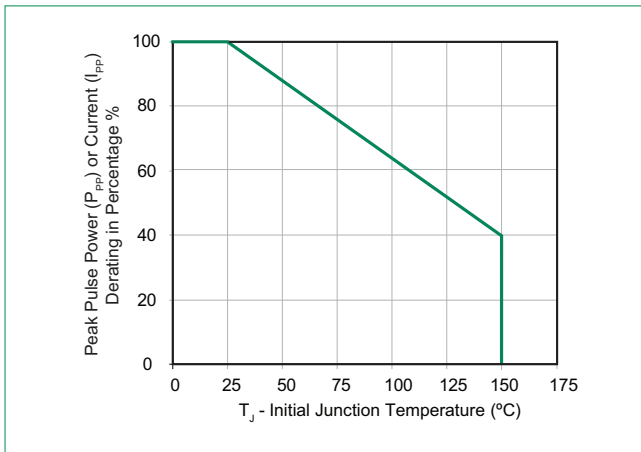
**Figure 1 - TVS Transients Clamping Waveform**



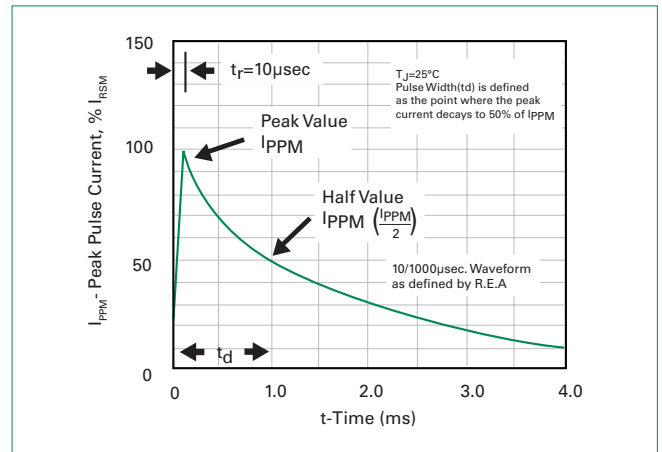
**Figure 2 - Peak Pulse Power Rating Curve**



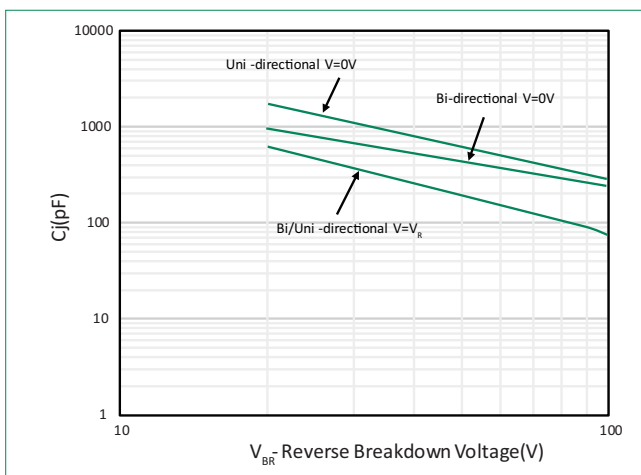
**Figure 3 - Peak Pulse Power Derating Curve**



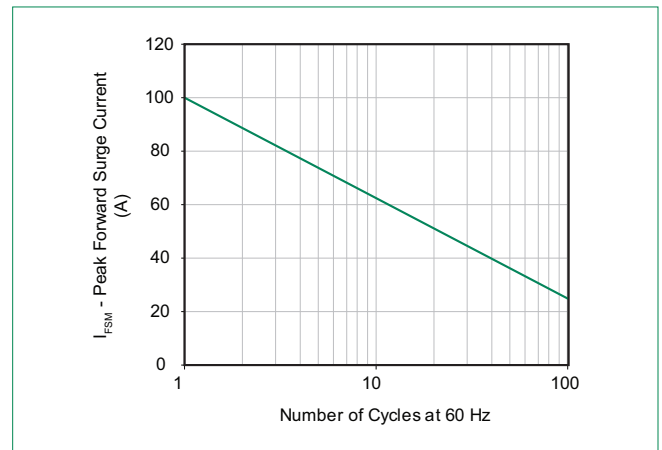
**Figure 4 - Pulse Waveform**



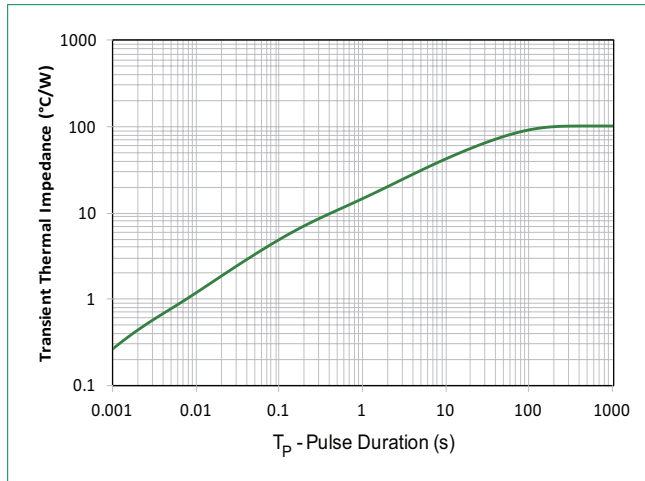
**Figure 5 - Typical Junction Capacitance**



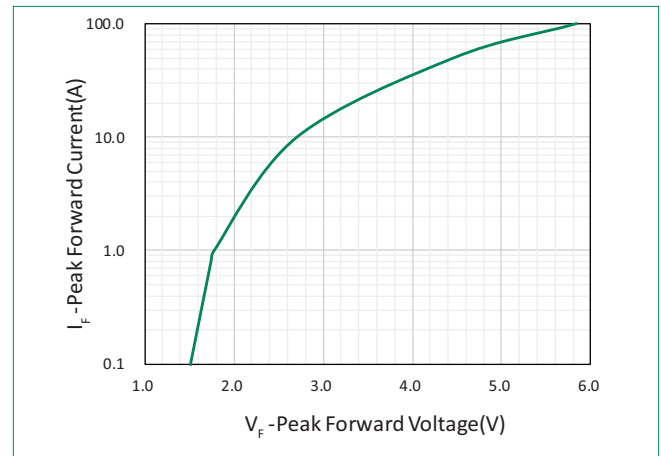
**Figure 6 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional Only**



**Figure 7 - Typical Transient Thermal Impedance**

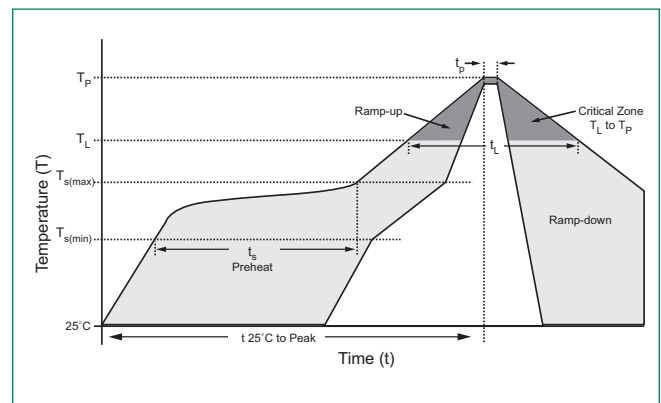


**Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)**



**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_A$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_A$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		260°C



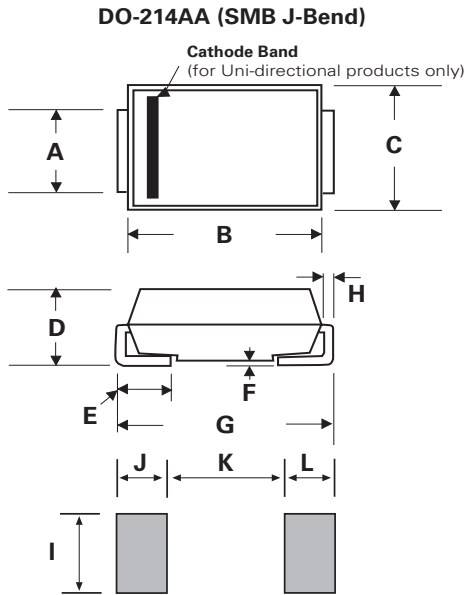
**Physical Specifications**

<b>Weight</b>	0.003 ounce, 0.093 grams
<b>Case</b>	JEDEC DO214AA. Molded plastic body over glass passivated junction
<b>Polarity</b>	Color band denotes cathode except Bidirectional.
<b>Terminal</b>	Matte Tin-plated leads, Solderable per JESD22-B102

**Environmental Specifications**

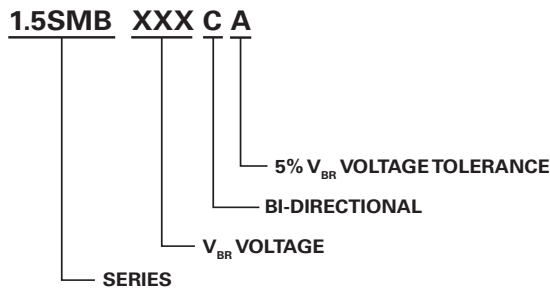
<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Temperature Cycling</b>	JESD22-A104
<b>MSL</b>	JEDEC-J-STD-020, Level 1
<b>H3TRB</b>	JESD22-A101
<b>RSH</b>	JESD22-A111

**Dimensions**

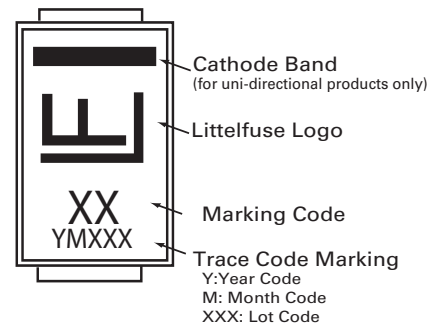


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.077	0.086	1.950	2.200
B	0.160	0.180	4.060	4.570
C	0.130	0.155	3.300	3.940
D	0.084	0.096	2.130	2.440
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.205	0.220	5.210	5.590
H	0.006	0.012	0.152	0.305
I	0.089	-	2.260	-
J	0.085	-	2.160	-
K	-	0.107	-	2.740
L	0.085	-	2.160	-

**Part Numbering System**



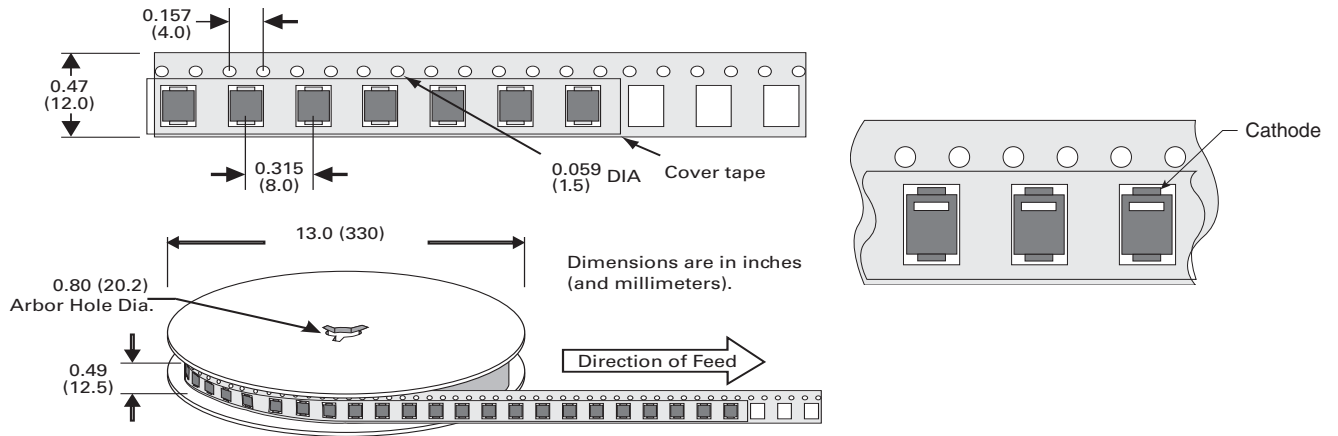
**Part Marking System**



**Packaging**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
1.5SMBxxxXX	DO-214AA	3000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

**Tape and Reel Specification**



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